

Ejecting Means In An IC Pack Connector Apparatus

Abstract of the Disclosure

A connector apparatus includes a header connector (10) of a given thickness into which an IC pack is loaded and from which it is ejected. An ejecting member (16) is mounted on the header connector (10) for ejecting the IC pack from the header connector. The ejecting member (16) is configured to lie substantially within the thickness profile of the IC pack. An actuating member (18) is provided for actuating the ejecting member (16) to eject the IC pack from the header connector. The actuating member is configured to lie substantially within the thickness profile of the header connector (fig. 1).

